

Tescan EXLO 800

TESCAN EXLO 800 represents our most advanced ex situ lift-out system to date and was designed to offer fast, easy, and reproducible manipulation of FIB-prepared S/TEM specimens.

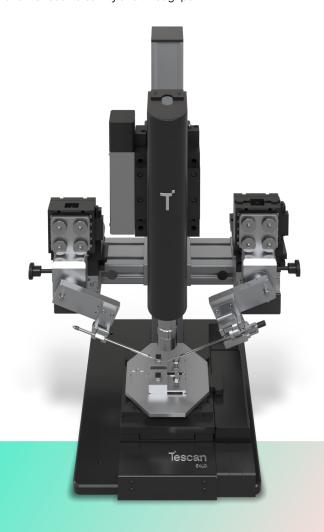
Each TESCAN EXLO 800 system comes fully equipped with a suite of advanced features designed for seamless, semi-automated ex situ manipulation. These include motorized focus control, a motorized lens changer and zoom, and a motorized XYZR manipulator with rotation for precise specimen handling. Additional components such as a glass tip puller, active suspension, and a user-friendly graphical software interface ensure smooth and efficient operation. The system can handle a wide range of sample sizes-including wafers and smaller specimens- up to 200 mm in diameter, and offers the flexibility of adding an optional second XYZ motorized manipulator for enhanced versatility and throughput.

The parfocal zoom microscope provides an unprecedented and continuous horizontal field of view- from ~ 3 mm down to 60 μ m. The UI can import or export a text file or CSV file of saved X, Y specimen coordinates. Global and nested saves are available for any motor or stage position for semi-automated operation from specimen to grid and back.

Engineered for high-throughput environments, TESCAN EXLO 800 is ideal for ex situ lift-out of several tens of specimens per hour and is compatible with multiple FIB instruments. When bundled with TESCAN's TEM AutoPrep Pro™ for preparing unattended specimens for S/TEM analysis, TESCAN EXLO 800 can significantly increase throughput and decrease the cost per specimen.



- The Pick&Place™ holder simplifies ex situ lift-out handling.
- The Aspirato[™] module offers vacuum-assisted ex situ manipulation for delicate operations.
- EXpressLO™ PGrids allow for front-side or back-side ex situ lift-out of various specimen sizes without the need for a carbon support film.
- EXpressLO-ZTM grids, made from nanocrystalline diamond, minimize X-ray overlap interference, reduce fluorescence and Bremsstrahlung during EDS analysis, and improve data quality.









Parfocal



Programmable joystick



Autofocus



Rotational micromanipulator



r center R



200 mm wafer sample



Remote



Product Specifications

Stage

Motorized stage travel (X & Y)	200 x 200 mm
Maximum specimen height	170 mm
Maximum specimen size	> 200 mm
Maximum specimen weight (XY moves)	40 kg

Optics

Parfocal zoom	
Horizontal field width (HFW)	60 µm to 3 mm
Working distance	20 mm
Resolution	<1µm
Light source	LED
Motorized focus travel	100 mm

Image acquisition

Maximum frame size (px x px)	1284×1024
Image and video formats	JPG/BMP/TIF/PNG/
	AVI

Camera

Camera USB3

Manipulator

Single motorized micromanipulator	
XYZ travel	25 mm
Omnidirectional repeatability (XYZ)	1μm
Maximum and minimum velocities	1 µm/s to 5 mm/s
Minimum step size	1μm
Continuous 360° rotation	
Precision of rotation	1°
Compucentric rotation	
Mouse gesture control	
2 nd manipulator (non-rotational)	Optional
Coordinate system transfer format	CSV/TXT

User interface

Control PC	Intel Core i5-14400, 10-core 4.7 GHz, RAM 1 x 8 GB DDR5 4800 MHz, 515 GB SSD M.2, GPU Intel UHD 730, Windows 11 Pro 64-bit
Keyboard and mouse	
Monitor	32"
Programmable joystick with buttons (model) X-Keys	
EXpressLO graphical user interface	

EXpressLO software

Multiuser account management
Globalicon saves
Nested saves
Click to center region of interest
Autofocus
Read/save positions from/to file
Unified UI for joystick programming
Video recording

Other accessories

Active antivibration system			
Pick&Place holder kit with Praxis samples			
Glass tip puller with glass rods			
EXpressLO PGrids (Cu)			
EXpressLO-Z NCD grids	Option	nal	
Aspirato (vacuum-assisted lift-out module)	Option	nal	
Sample platen		sample m wafer	and

Installation requirements

Power supply	Power supply: 230 V ± 10% / 50 Hz (or 120 V /60 Hz-optional)
Room for installation	2600 x 2300 mm

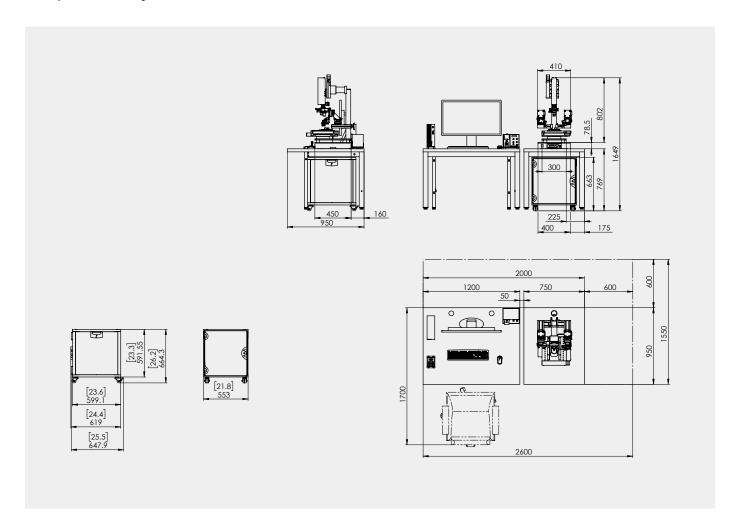
Environmental requirements

Temperature	17-24°C
Humidity	< 65 %
Vibrations	Vibrations: <10 µm/s below 30 Hz, <20 µm/s above 30 Hz
Acoustic level	<60 dBC

Training

Introductory: By TESCAN engineer after installation

Footprint of the system



©TESCAN GROUP, a.s.

Technologies used are protected by patents, for instance US8,740,210; US8,789,827; US10,522,325; US10,801,927 EXpressLO[™], EXpressLO-Z[™], Pick&Place[™], Aspirato[™], Praxis[™] are trademarks of TESCAN GROUP, a.s. We are constantly improving the performance of our products, so all specifications are subject to change without notice.

Owners of TESCAN products must agree to and comply with the End User License Agreement (EULA): www.tescan.com/end-user-licence-agreement-1-0



TESCAN GROUP, a.s.

Libušina tř. 21, 623 00 Brno - Kohoutovice / Czech Republic (phone) +420 530 353 411 / (email) sales@tescan.com / marketing@tescan.com